

8-Bit Low Cost Signal Conditioning ADC

AD670

1.0 **SCOPE**

This specification documents the detailed requirements for Analog Devices space qualified die including die qualification as described for Class K in MIL-PRF-38534, Appendix C, Table C-II except as modified herein.

The manufacturing flow described in the STANDARD DIE PRODUCTS PROGRAM brochure at http://www.analog.com/marketSolutions/militaryAerospace/pdf/Die Broc.pdf is to be considered a part of this specification.

This data sheet specifically details the space grade version of this product. A more detailed operational description and a complete data sheet for commercial product grades can be found at www.analog.com/AD670

2.0 **Part Number.** The complete part number(s) of this specification follow:

Part Number

Description AD670-000C

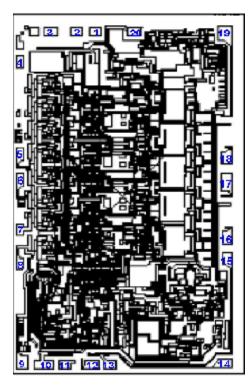
8-Bit Low Cost Signal Conditioning ADC

3.0 **Die Information**

Die Dimensions 3.1

Die Size	Die Thickness mil	Bond Pad Metalization
111 mil x 174 mil	19 mil ± 2 mil	Al/Cu

3.2 Die Picture



ASD0012807

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- 1. D0 (LSB)
- 2. D1
- 3. D2
- 4. D3
- 5. D4
- 6. D5
- 7. D6
- 8. D7 (MSB)
- **STATUS**
- 10. POWER GROUND
- 11. BPO/UPO*
- 12. FORMAT
- 13. R/W*
- 14. CE*
- 15. CS*
- 16. -VIN HI

- * = Active Low
- 17. -VIN LOW
- 18. +VIN HI
- 19. +VIN LOW
- 20. +VCC

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3.3 **Absolute Maximum Ratings** 1/

V_{CC} to Ground 0V to +7.5V

Digital Inputs (Pin 11 – 15)-0.5V to V_{CC} +0.5V

Digital Outputs (Pin 1 − 9)...... Momentary Short to V_{CC} or ground

Analog Inputs (Pin 16 – 19) ±30V

Storage Temperature Range--65°C to +150°C

Junction Temperature (T_J).....+150C

Operating Temperature Range.....--55°C to +125°C

Absolute Maximum Ratings Notes:

1./ Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.

4.0 <u>Die Qualification</u>

In accordance with class-K version of Mil-Prf-38534, Appendix C, Table C-II, except as modified herein.

- (a) Qual Samples Size and Qual Acceptance Criteria 25/2
- (b) Qual Sample Package DIP
- (c) Pre-screen electrical test over temperature performed post-assembly prior to die qualification.

Table I -Dice Electrical Characteristics							
Parameter	Symbol	Conditions <u>1</u> /	Limit Min	Limit Max	Units		
Relative Accuracy	RA	<u>2</u> /		±0.5	LSB		
Differential Nonlinearity	DNL	<u>3</u> / <u>4</u> /	8		Bits		
Gain Error	AE	2/		±1.5	LSB		
Unipolar Offset Error	OE	0V to +2.55V input range FS		±1	LSB		
Bipolar Offset Error	Boe	-1.28V to +1.27V FS		±1	LSB		
Power Supply Current	lcc	VCC = 5.5V (DB0-DB7, R/W - High); (STATUS, CE, CS, FORMAT, BPO, UPO - LOW)		45	mA		
Digital Input High Voltage	V _{IH}	<u>4</u> /	2		V		
Digital Input Low Voltage	V _{IL}	<u>4</u> /		0.8	V		
Digital Input High Current	I _{IH}	V _{IH} = 5V <u>4</u> /		100	μΑ		
Digital Input Low Current	I⊫	V _{IL} = 0V <u>4</u> /	-100		μΑ		
Digital Output Low Voltage	V _{OL}	$I_{OL} = 1.6 \text{mA}, V_{CC} = 5.5 \text{V}$		0.4	V		
Digital Output High Voltage	Vон	I _{OH} = 0.5mA, V _{CC} = 4.5V 2.4			V		
Three-State Leakage Current	loz	Vapplied = 0V and 5V <u>4</u> / ±40		±40	μΑ		
Conversion Time	Tc			10	μs		

Table I Notes:

 $[\]underline{1}/V_{CC}$ = +5V, T_A = 25°C, unless otherwise specified.

^{2/} Tested on both 2.55V full scale and -1.28V to 1.27V full scale.

^{3/} Minimum resolution for which there are no missing codes.

 $[\]underline{4}$ / Parameter is tested at V_{CC} = +5V, but is guaranteed from V_{CC} = 4.5V to V_{CC} = 5.5V.

Table II -Electrical Characteristics for Qual Samples							
Parameter	Symbol	Conditions <u>1</u> /	Sub- groups	Limit Min	Limit Max	Units	
Relative Accuracy	RA	2/	1		±0.5	LSB	
Helative Accuracy	101	₹/	2, 3		±1	LJD	
Differential Nonlinearity	DNL	<u>3</u> /, <u>4</u> /	1, 2, 3	8		Bits	
Gain Error	A _E	2/	1		±1.5	LCD	
Gaill Elloi	\ \AE	<u>2</u> /	2, 3		±2.5	LSB	
Unipolar Offset Error	0V to +2.55V	1		±1	LCD		
Onipolar Offset Error	OE	input range FS	2, 3		±2	LSB	
Distalan Office Foreign	Di 1 0% 15	1		±1	LCD		
Bipolar Offset Error	Вов	-1.28V to +1.27V FS	2, 3		±2	LSB	
Power Supply Current	lcc	VCC = 5.5V (DB0-DB7, R/W - High); (STATUS, CE, CS, FORMAT, BPO, UPO - LOW)	1, 2, 3		45	mA	
Digital Input High Voltage	V _{IH}	<u>4</u> /	1, 2, 3	2		V	
Divited by Males of	\ /II	4/	1		0.8	17	
Digital Input Low Voltage	VIL	<u>4</u> /	2, 3		0.7	V	
Digital Input High Current	IIH	V _{IH} = 5V <u>4</u> /	1, 2, 3		100	μΑ	
Digital Input Low Current	I _{IL}	V _{IL} = 0V <u>4</u> /	1, 2, 3	-100		μΑ	
Digital Output Low Voltage	VoL	$I_{OL} = 1.6 \text{mA},$ $V_{CC} = 5.5 \text{V}$	1, 2, 3		0.4	V	
Digital Output High Voltage	Vон	I _{OH} = 0.5mA, V _{CC} = 4.5V	1, 2, 3	2.4		V	
Three-State Leakage Current <u>4</u> /	loz	Vapplied = 0V and 5V	1, 2, 3		±40	μΑ	

Table II Notes:

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Table III - Life Test Endpoint and Delta Parameter (Product is tested in accordance with Table II with the following exceptions)

Parameter	Symbol	Sub- groups	Post Burn In Limit		Post Life Test Limit		Life Test	Units
			Min	Max	Min	Max	Delta	Ollits
Power Supply Current	lcc	1		50		55	±5	- mA
		2, 3				55		
Digital Output High Voltage	Vон	1	2.4		2.4		±.2	V
		2, 3			2.4]
Digital Output Low Voltage	V _{OL}	1		0.4		0.4	±.1	V
		2, 3				0.4		

5.0 <u>Life Test/Burn-In Information</u>

- 5.1 HTRB is not applicable for this drawing.
- 5.2 Burn-in is per MIL-STD-883 Method 1015 test condition B or C.
- 5.3 Steady state life test is per MIL-STD-883 Method 1005.

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Rev	Description of Change	Date
Α	Initiate	20-DEC-01
В	Correct typo's on table III. VOH is 2.4V minimum. Remove \pm from endpoint limits.	27-Mar-02
C	Update web address. Make revision letter same on all pages	4-Mar-03
D	Update 1.0 Scope description	11-Jul-07
Е	Update header/footer & add to 1.0 Scope Description.	19-Feb-08
F	Add Junction Temperature (T _J)+150°C to 3.3 Absolute Maximum Ratings	March 31, 2008
G	Updated Section 4.0c note to indicate pre-screen temp testing being performed.	6-JUN-2009
Н	Updated fonts and sizes to ADI standards	22-Sep-2011